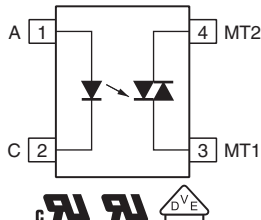


Optocoupler, Phototriac Output, Non-Zero Crossing, High dV/dt, Low Input Current, SOP-4 Package



22995



FEATURES

- Flat 2.0 mm SOP-4 package
- High static dV/dt 1000 V/μs
- High input sensitivity $I_{FT} = 10$ mA
- 100 mA on-state current
- 800 V peak off-state blocking voltage
- Isolation rated voltage 3750 V_{RMS}
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


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DESCRIPTION

The VOT8121AM consists of a GaAs IRLED optically coupled to a photosensitive TRIAC packaged in a board space saving tiny flat SOP-4 package.

The VOT8121AM isolates low-voltage logic from 120 V_{AC}, 240 V_{AC}, and 380 V_{AC} lines to control resistive, inductive, or capacitive loads including motors, solenoids, high current thyristors or TRIAC and relays.

APPLICATIONS

- Power TRIAC driver in solid-state relays
- 3-phase AC equipment
- Motor control
- Industrial control
- White goods / household equipment

AGENCY APPROVALS

- [UL 1577](#)
- [cUL](#)
- [DIN EN 60747-5-5 \(VDE 0884-5\), available with option "V"](#)

ORDERING INFORMATION

V	O	T	8	1	2	1	A	M	-	V	T	#
PART NUMBER									VDE OPTION	TAPE AND REEL		

AGENCY CERTIFIED/PACKAGE	TRIGGER CURRENT, I_{FT} (mA)
UL, cUL	10
SOP-4	VOT8121AM-T
SOP-4, 180° orientation	VOT8121AM-T2
VDE, UL, cUL	10
SOP-4	VOT8121AM-VT
SOP-4, 180° orientation	VOT8121AM-VT2

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V_R	6	V
Forward current		I_F	50	mA
Power dissipation		P_{diss}	70	mW
OUTPUT				
Peak off-state voltage		V_{DRM}	800	V
RMS on-state current		$I_{T(RMS)}$	100	mA
Power dissipation		P_{diss}	300	mW
Peak repetitive surge current	PW = 1 ms, 120 pps	I_{TSM}	1	A
COUPLER				
Storage temperature range		T_{stg}	-55 to +150	$^{\circ}\text{C}$
Ambient temperature range		T_{amb}	-55 to +110	$^{\circ}\text{C}$
Total power dissipation		P_{diss}	330	mW
Soldering temperature	For 10 s	T_{sld}	260	$^{\circ}\text{C}$

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
This phototriac should not be used to drive a load directly. It is intended to be a trigger device only

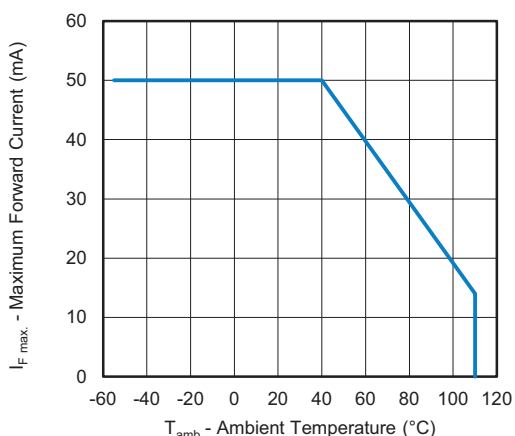


Fig. 1 - Maximum Forward Current vs. Ambient Temperature

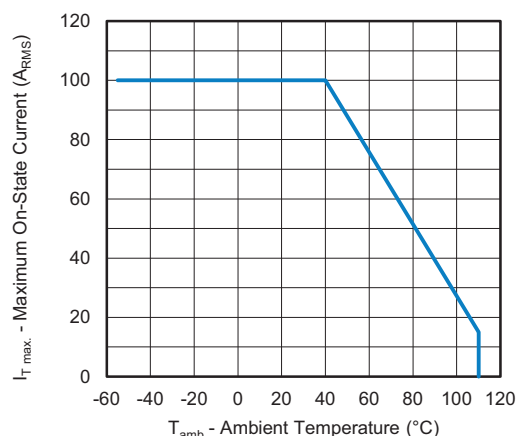


Fig. 2 - Maximum On-State Current vs. Ambient Temperature



ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	$I_F = 20\text{ mA}$	V_F	-	1.15	1.5	V
Reverse current	$V_R = 6\text{ V}$	I_R	-	-	10	μA
OUTPUT						
Off-state current	$V_{DRM} = 800\text{ V}$	I_{DRM}	-	-	0.1	μA
On-state voltage	$I_T = 100\text{ mA peak}$	V_{TM}	-	1.7	3	V
Holding current		I_H	-	250	-	μA
Critical rate of rise of off-state voltage		$dV/dt^{(1)}$	1000	-	-	V/ μs
COUPLER						
Trigger current	$V_{TM} = 3\text{ V}$	I_{FT}	-	-	10	mA

Notes

- Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements

⁽¹⁾ Static dV/dt

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$V_D = 6\text{ V to }4\text{ V}$, $R_L = 100\text{ }\Omega$, $I_F = \text{rated } I_{FT} \times 1.5$	t_{on}	-	30	100	μs

Note

- Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements

SAFETY AND INSULATION RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 115 / 21	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	V_{ISO}	3750	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	6000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	565	V_{peak}
Isolation resistance	$V_{IO} = 500\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	R_{IO}	10^{12}	Ω
	$V_{IO} = 500\text{ V}$, $T_{amb} = 100\text{ }^{\circ}\text{C}$	R_{IO}	10^{11}	Ω
Output safety power		P_{SO}	300	mW
Input safety current		I_{SI}	50	mA
Input safety temperature		T_S	150	$^{\circ}\text{C}$
Creepage distance			> 5	mm
Clearance distance			> 5	mm
Insulation thickness		DTI	> 0.4	mm

Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits

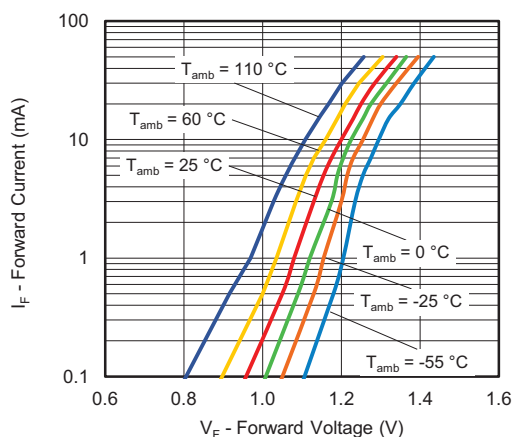
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 3 - Forward Current vs. Forward Voltage

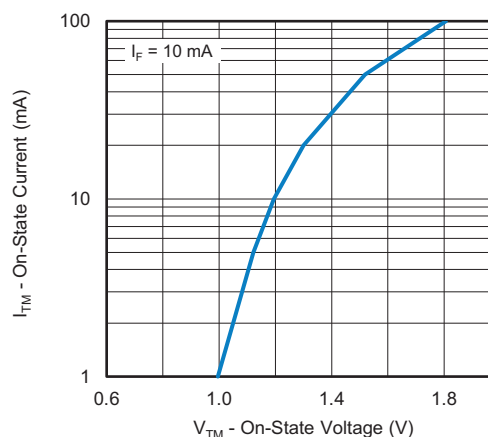


Fig. 6 - On State Current vs. On State Voltage

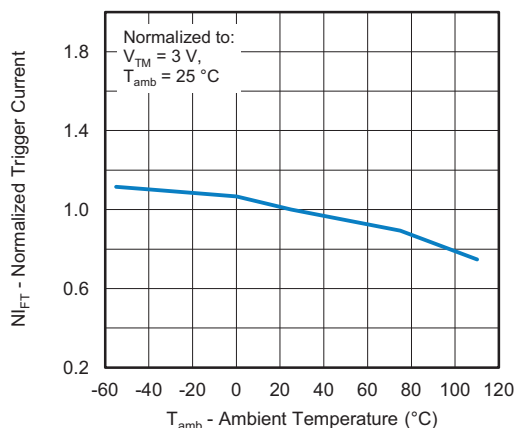


Fig. 4 - Normalized Trigger Current vs. Ambient Temperature

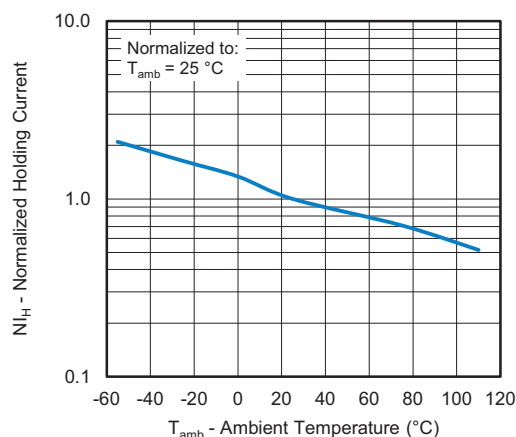


Fig. 7 - Normalized Holding Current vs. Ambient Temperature

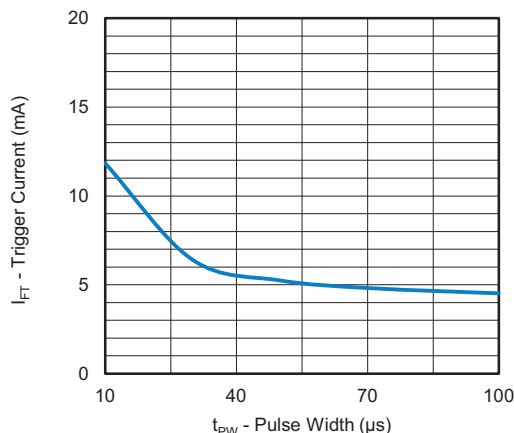


Fig. 5 - Trigger Current vs. Pulse Width

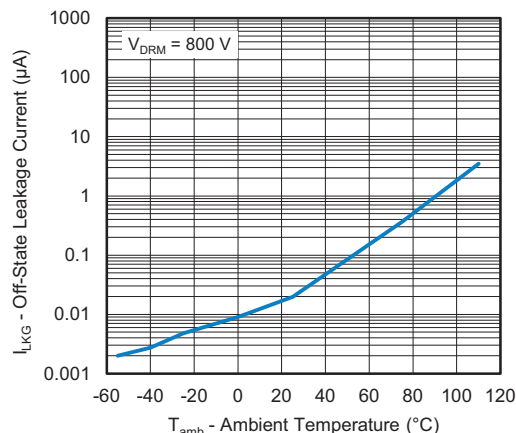


Fig. 8 - Off-State Leakage Current vs. Ambient Temperature

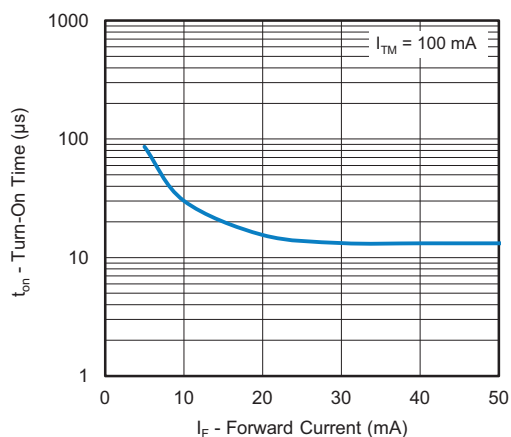


Fig. 9 - Turn-On Time vs. Forward Current

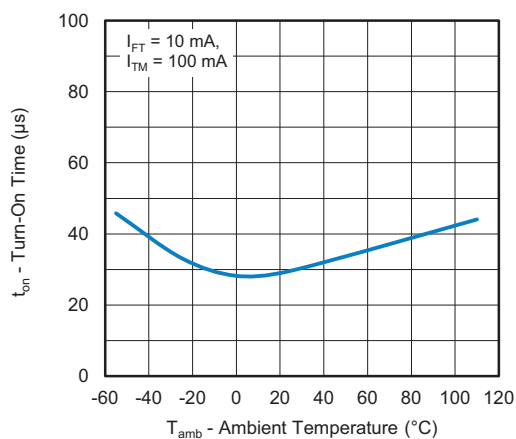


Fig. 10 - Turn-On Time vs. Ambient Temperature

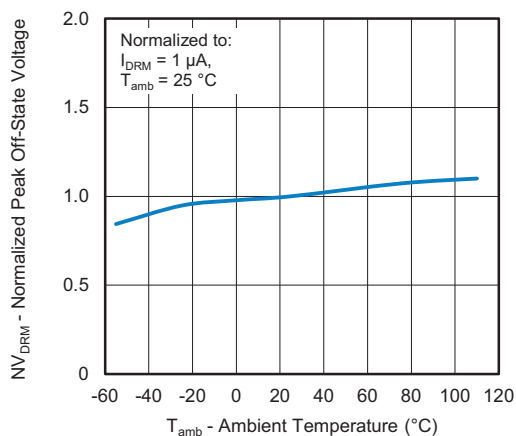


Fig. 11 - Normalized Peak Off-State Voltage vs. Ambient Temperature

PACKAGE DIMENSIONS (in millimeters)

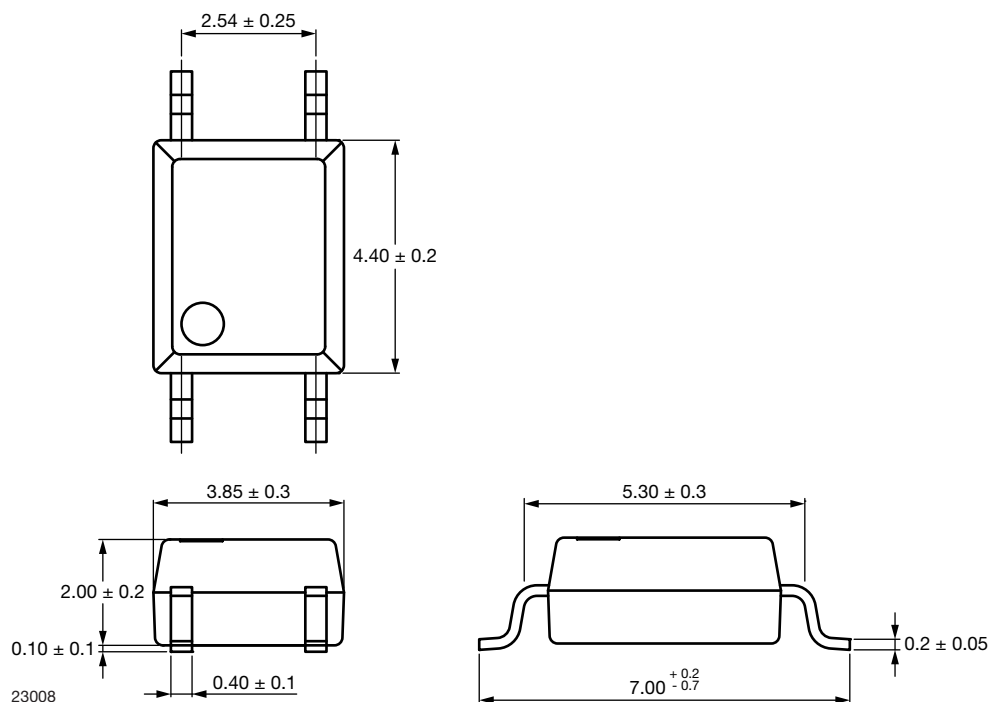
SOP-4


Fig. 1

PACKAGE MARKING


Fig. 12 - Example of VOT8121AM-VT

Notes

- "YWW" is the date code marking (Y = year code, WW = week code)
- "X" is only marked on VDE option parts
- Tape and reel suffix (T) is not part of the package marking

PACKAGING INFORMATION (in millimeters)

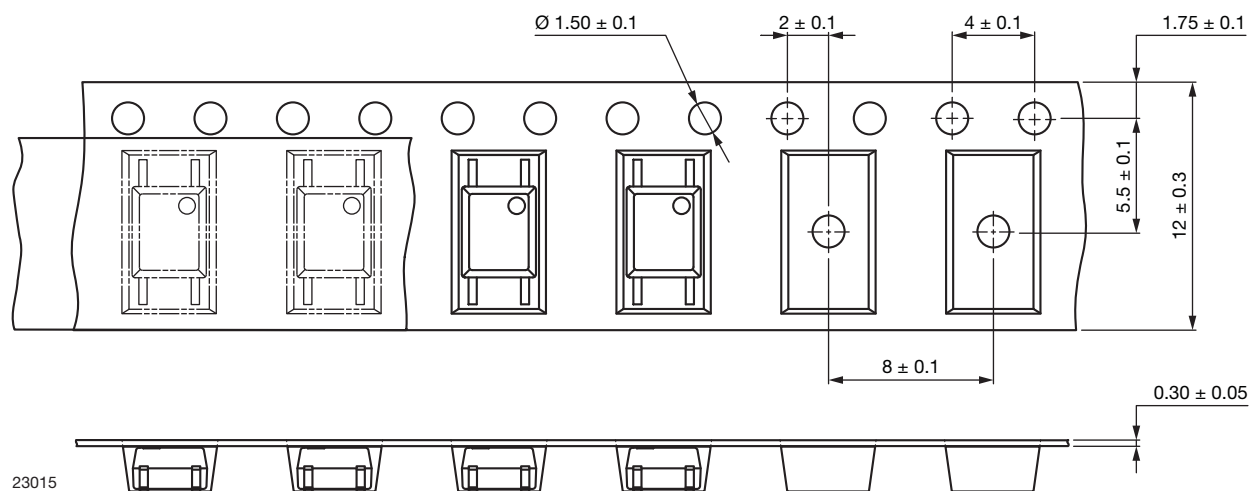
Tape SOP-4


Fig. 13 - Tape and Reel Packaging (3000 pieces on reel)

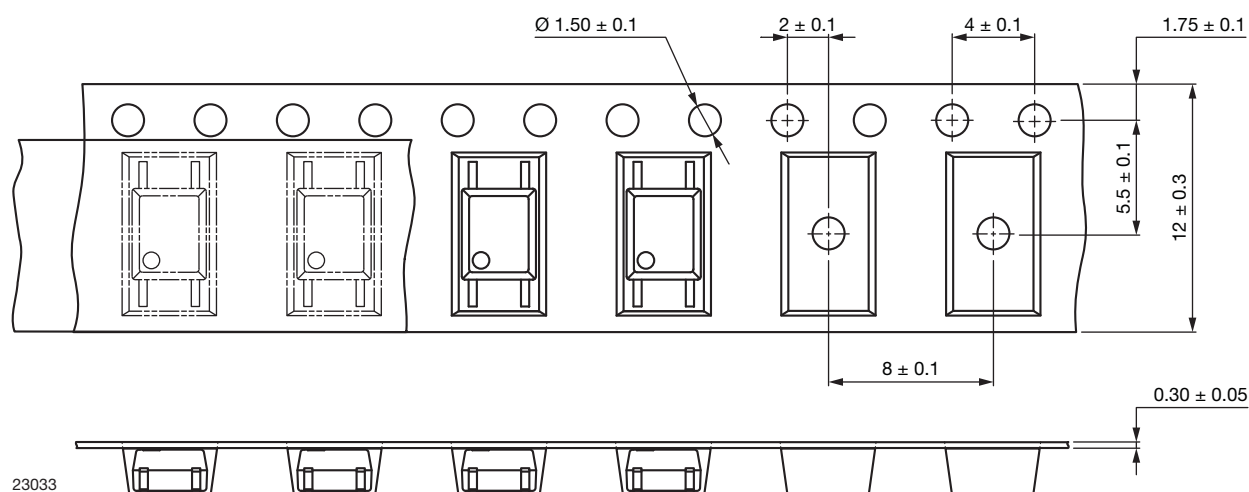
Tape SOP-4, 180° Orientation


Fig. 14 - Tape and Reel Packaging (3000 pieces on reel)

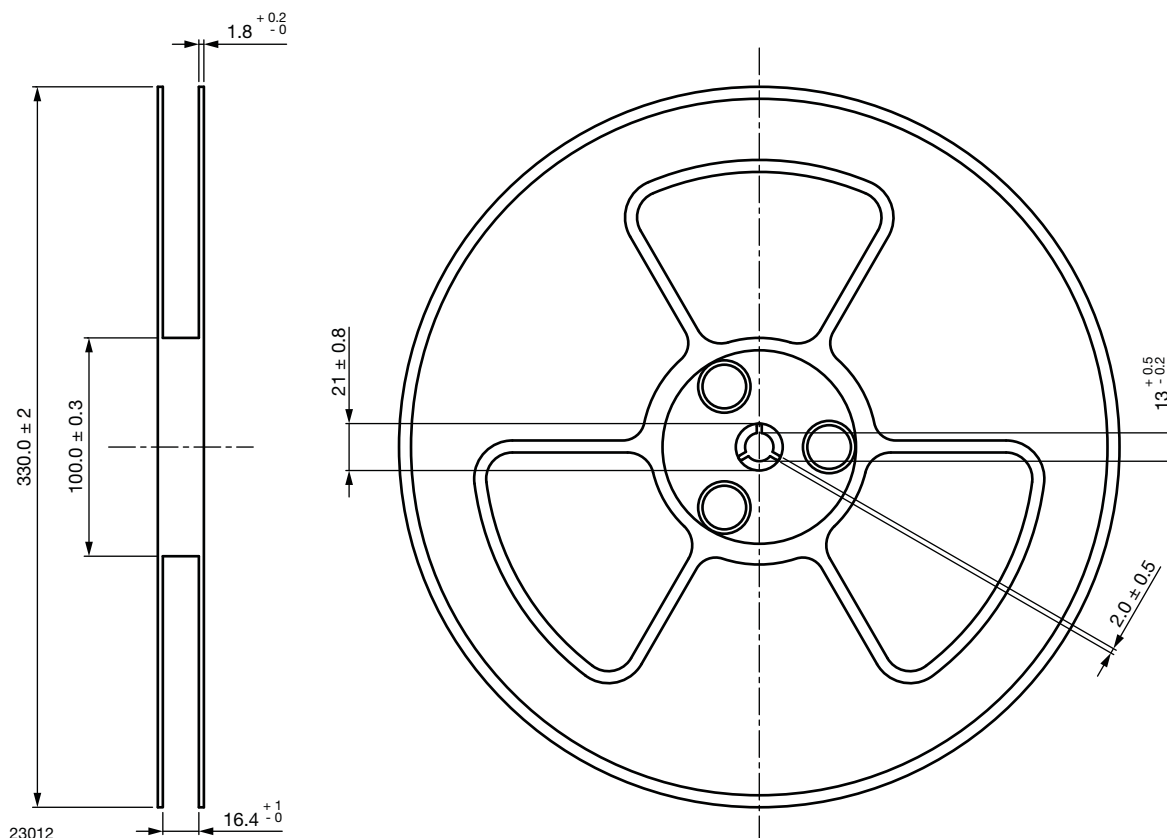
Reel


Fig. 15 - Tape and Reel Shipping Medium

SOLDER PROFILES

IR Reflow Soldering (JEDEC® J-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

PROFILE ITEM	CONDITIONS
Preheat	
- Temperature minimum ($T_{S \text{ min.}}$)	150 °C
- Temperature maximum ($T_{S \text{ max.}}$)	200 °C
- Time (min. to max.) (t_S)	90 s $\pm$ 30 s
Soldering zone	
- Temperature (T_L)	217 °C
- Time (t_L)	60 s
Peak temperature (T_p)	260 °C
Ramp-up rate	3 °C/s max.
Ramp-down rate	3 °C/s to 6 °C/s

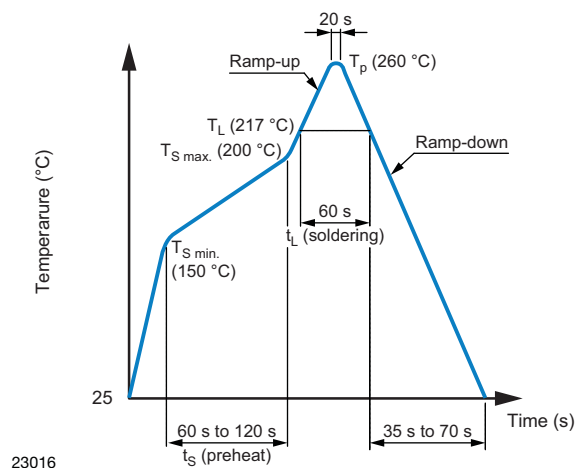


Fig. 2

Wave Soldering (JEDEC JESD22-A111 compliant)

One time soldering is recommended within the condition of temperature.

Temperature: 260 °C + 0 °C / - 5 °C

Time: 10 s

Preheat temperature: 25 °C to 140 °C

Preheat time: 30 s to 80 s

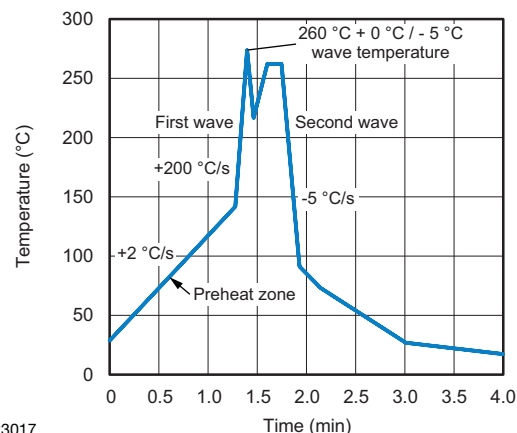


Fig. 3

Hand Soldering by Soldering Iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380 °C + 0 °C / - 5 °C

Time: 3 s max.

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30 \text{ °C}$, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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